

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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PHOTOCOUPLER
PS2911-1

**HIGH CTR, 4-PIN ULTRA SMALL PACKAGE
FLAT-LEAD PHOTOCOUPLER**

–NEPOC Series–

DESCRIPTION

The PS2911-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor in one package for high density mounting applications.

An ultra small flat-lead package has been provided which realizes a reduction in mounting area of about 30% compared with the PS28xx series.

FEATURES

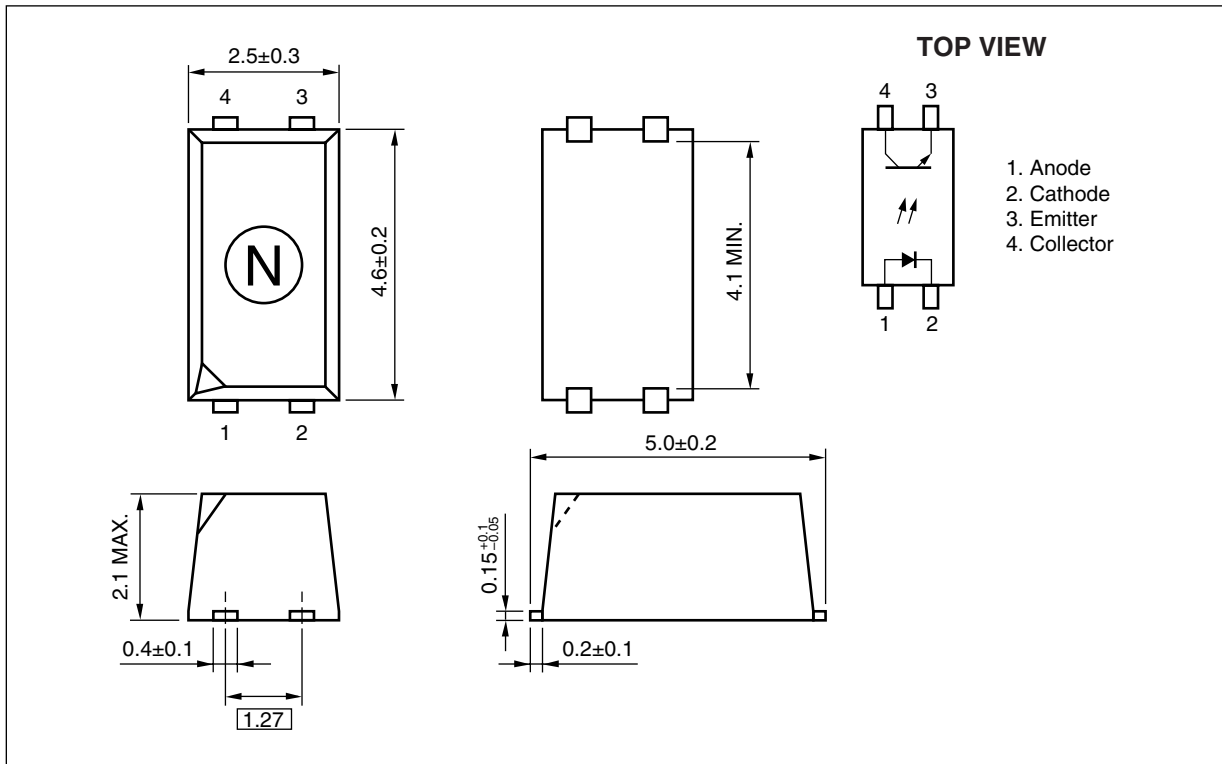
- Ultra small flat-lead package (4.6 (L) × 2.5 (W) × 2.1 (H) mm)
- High current transfer ratio (CTR = 200% TYP. @ $I_F = 1 \text{ mA}$, $V_{CE} = 5 \text{ V}$)
- High isolation voltage ($BV = 2\,500 \text{ Vr.m.s.}$)
- Ordering number of taping product: PS2911-1-F3, F4: 3 500 pcs/reel
- <R> • Safety standards
 - UL approved: File No. E72422
 - BSI approved: No. 8657, 8658
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

APPLICATIONS

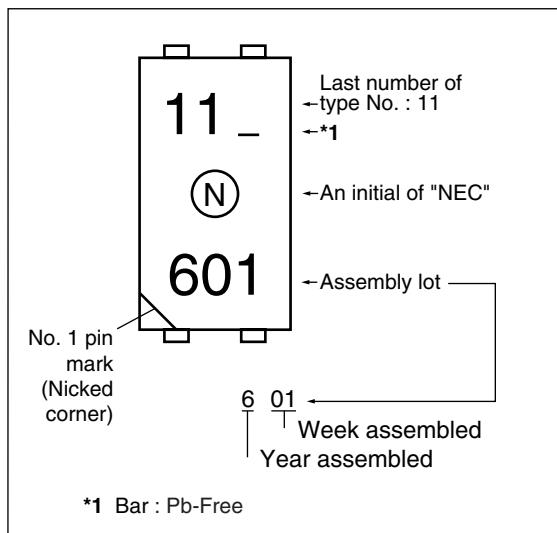
- DC/DC converter
- Modem/PC card

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PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



PHOTOCOUPLER CONSTRUCTION

| Parameter | Unit (MIN.) |
|--------------------|-------------|
| Air Distance | 4 mm |
| Creepage Distance | 4 mm |
| Isolation Distance | 0.4 mm |

<R> ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ^{*1} |
|---------------|-----------------|------------------------------|------------------------------|---|---------------------------------------|
| PS2911-1 | PS2911-1-A | Pb-Free | 50 pcs (Tape 50 pcs cut) | Standard products (UL, BSI approved) | PS2911-1 |
| PS2911-1-F3 | PS2911-1-F3-A | | Embossed Tape 3 500 pcs/reel | | |
| PS2911-1-F4 | PS2911-1-F4-A | | | | |
| PS2911-1-V | PS2911-1-V-A | | 50 pcs (Tape 50 pcs cut) | DIN EN60747-5-2 | |
| PS2911-1-V-F3 | PS2911-1-V-F3-A | | Embossed Tape 3 500 pcs/reel | (VDE0884 Part2) | |
| PS2911-1-V-F4 | PS2911-1-V-F4-A | | | Approved (Option) | |

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

| Parameter | | Symbol | Ratings | Unit |
|---------------------------------|------------------------------------|---------------------|-------------|---------|
| Diode | Forward Current | I _F | 50 | mA |
| | Forward Current Derating | ΔI _F /°C | 0.5 | mA/°C |
| | Peak Forward Current ^{*1} | I _{FP} | 0.5 | A |
| | Power Dissipation | P _D | 60 | mW |
| | Reverse Voltage | V _R | 6 | V |
| Transistor | Collector to Emitter Voltage | V _{CEO} | 40 | V |
| | Emitter to Collector Voltage | V _{ECO} | 5 | V |
| | Collector Current | I _C | 40 | mA |
| | Power Dissipation Derating | ΔP _C /°C | 1.2 | mW/°C |
| | Power Dissipation | P _C | 120 | mW |
| Isolation Voltage ^{*2} | | BV | 2 500 | Vr.m.s. |
| Total Power Dissipation | | P _T | 160 | mW |
| Operating Ambient Temperature | | T _A | -55 to +100 | °C |
| Storage Temperature | | T _{stg} | -55 to +150 | °C |

*1 PW = 100 μs, Duty Cycle = 1%

*2 AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output
Pins 1-2 shorted together, 3-4 shorted together.

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

| Parameter | | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|------------------------|--|----------------------|--|------------------|------|------|------|
| Diode | Forward Voltage | V _F | I _F = 1 mA | 0.9 | 1.1 | 1.3 | V |
| | Reverse Current | I _R | V _R = 5 V | | | 5 | μA |
| | Terminal Capacitance | C _t | V = 0 V, f = 1 MHz | | 15 | | pF |
| Transistor | Collector to Emitter Dark Current | I _{CEO} | I _F = 0 mA, V _{CE} = 40 V | | | 100 | nA |
| Coupled | Current Transfer Ratio (I _c /I _F) ^{*1} | CTR | I _F = 1 mA, V _{CE} = 5 V | 100 | 200 | 400 | % |
| | Collector Saturation Voltage | V _{CE(sat)} | I _F = 1 mA, I _c = 0.2 mA | | 0.13 | 0.3 | V |
| | Isolation Resistance | R _{I-O} | V _{I-O} = 1 kV _{DC} | 10 ¹¹ | | | Ω |
| | Isolation Capacitance | C _{I-O} | V = 0 V, f = 1 MHz | | 0.4 | | pF |
| | Rise Time ^{*2} | t _r | V _{CC} = 5 V, I _c = 2 mA, R _L = 100 Ω | | 5 | | μs |
| | Fall Time ^{*2} | t _f | | | 10 | | |
| | On Time ^{*2} | t _{on} | V _{CC} = 5 V, I _F = 1 mA, R _L = 5 kΩ | | 40 | | μs |
| | Storage Time ^{*2} | t _s | | | 10 | | μs |
| Off Time ^{*2} | t _{off} | | | | 120 | | μs |

***1 CTR rank**

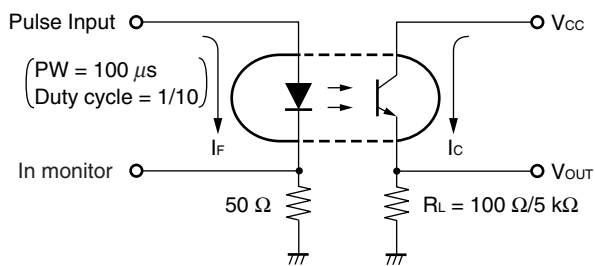
N : 100 to 400 (%)

K : 200 to 400 (%)

L : 150 to 300 (%)

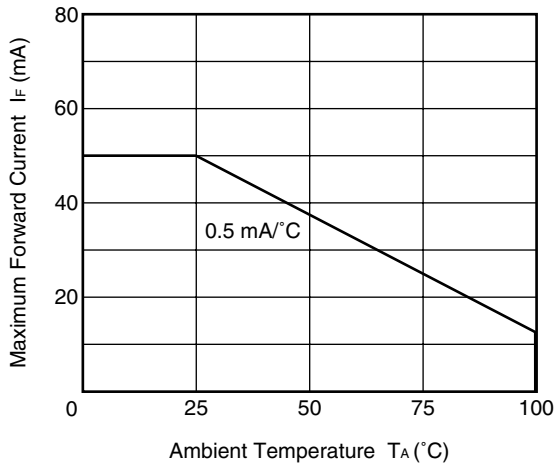
M : 100 to 200 (%)

***2 Test circuit for switching time**

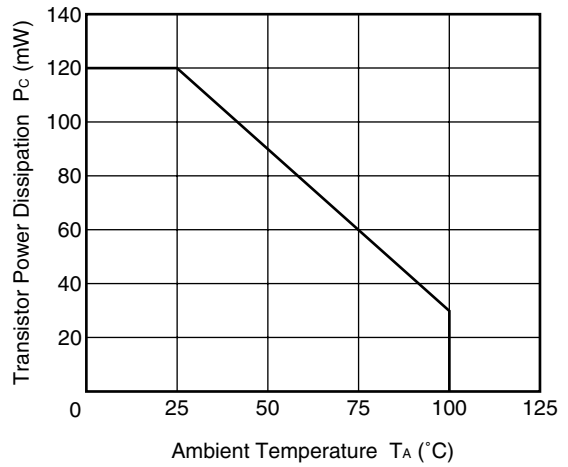


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

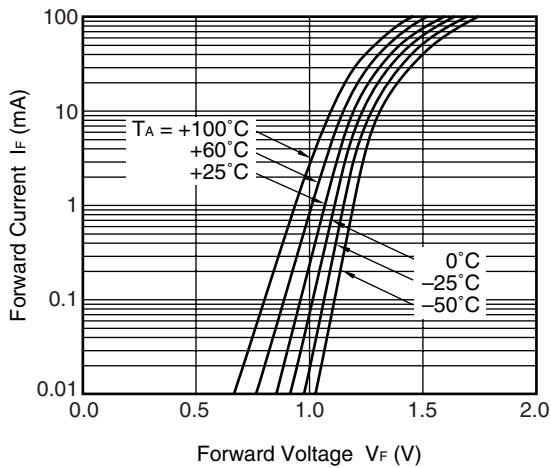
MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE



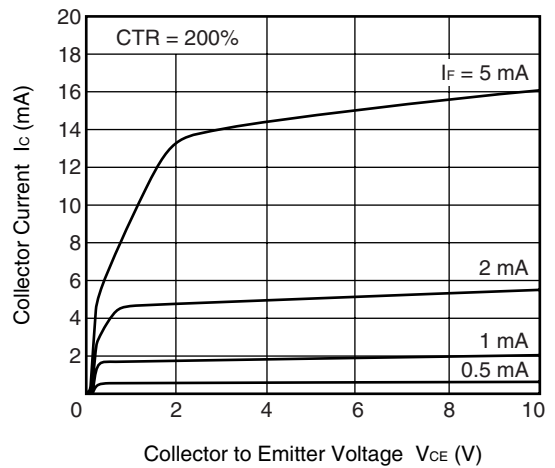
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



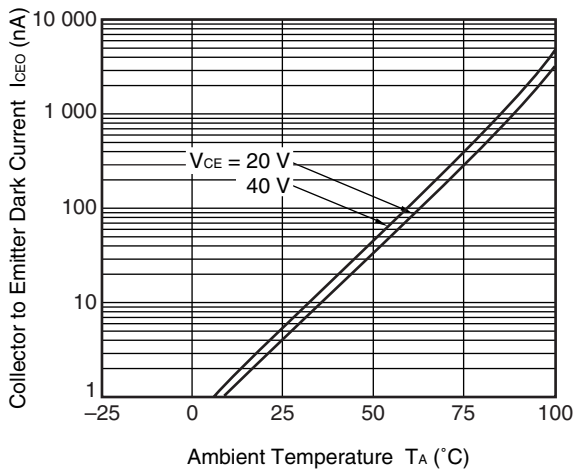
FORWARD CURRENT vs. FORWARD VOLTAGE



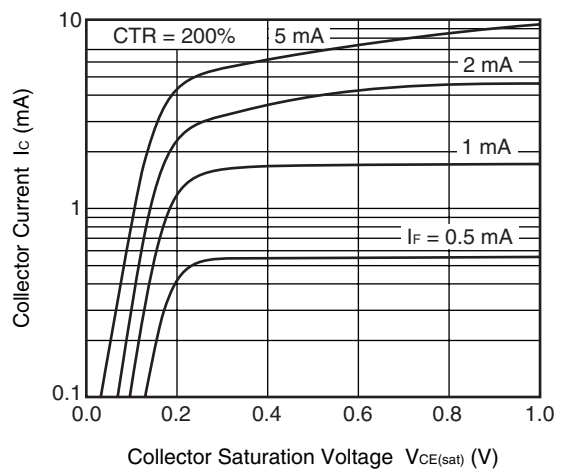
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

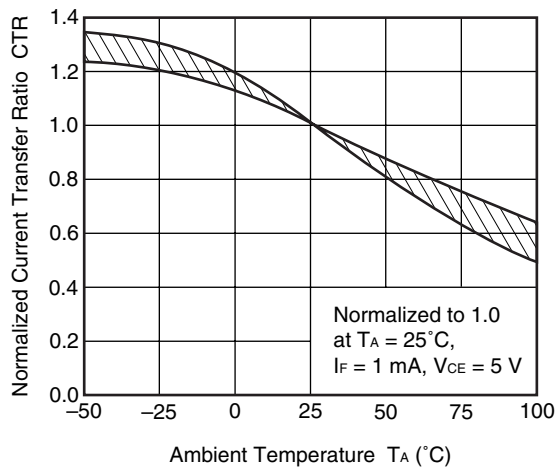


COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE

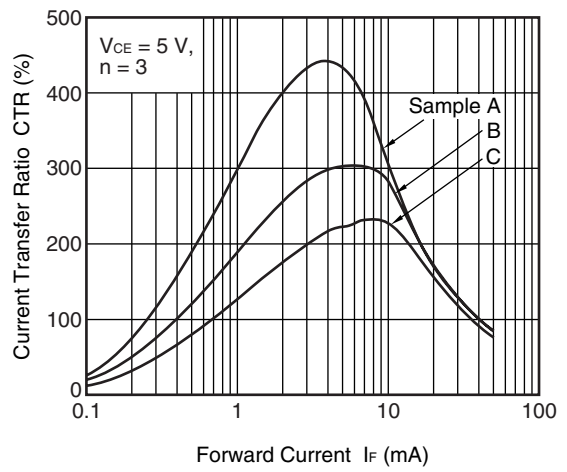


Remark The graphs indicate nominal characteristics.

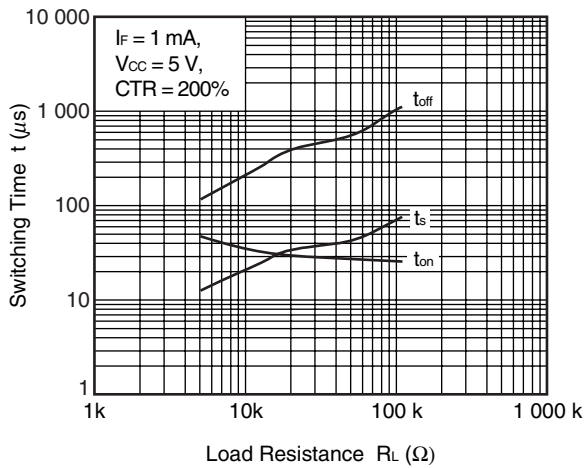
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



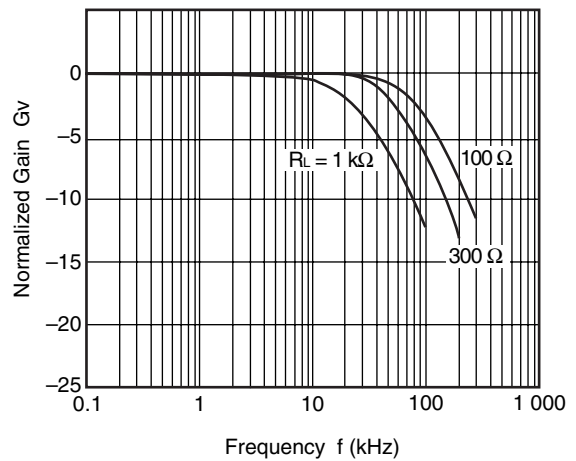
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



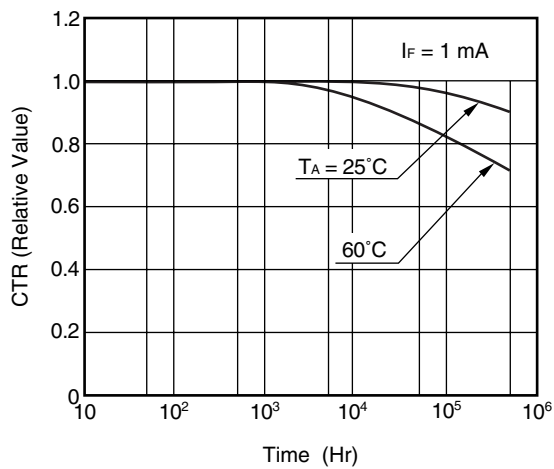
SWITCHING TIME vs. LOAD RESISTANCE



FREQUENCY RESPONSE



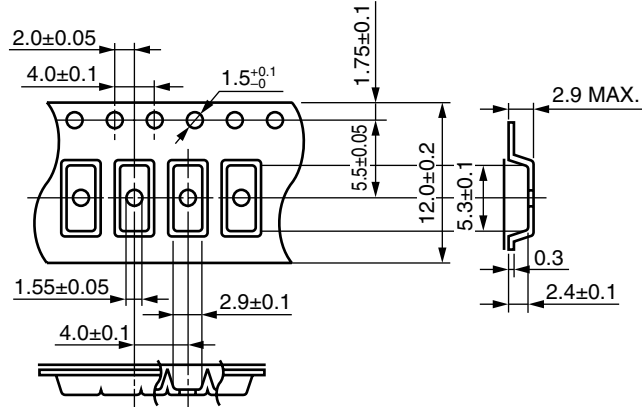
LONG TERM CTR DEGRADATION



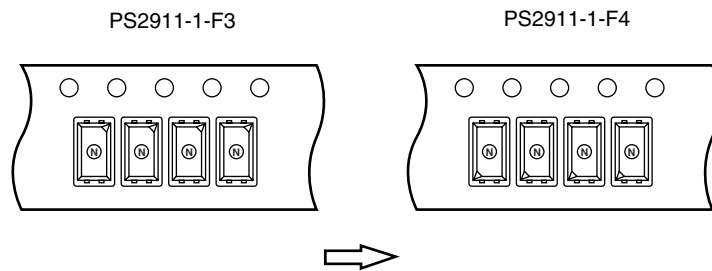
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

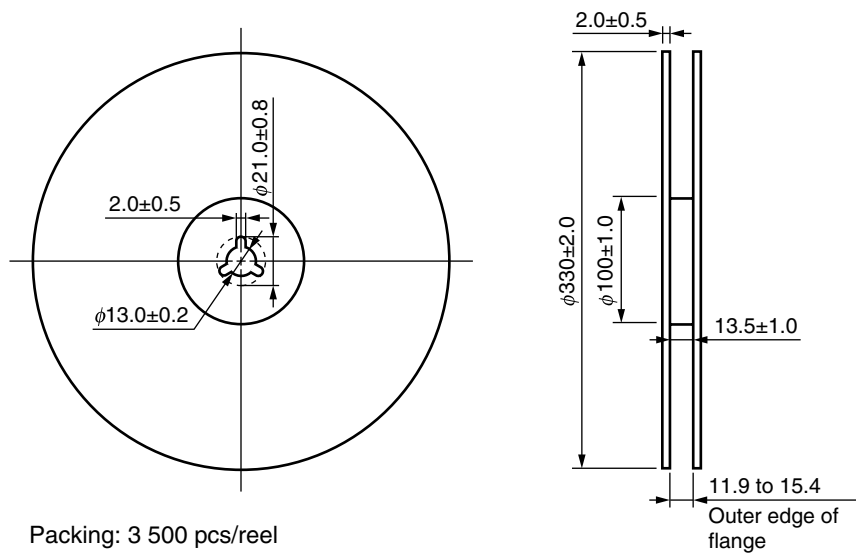
Outline and Dimensions (Tape)



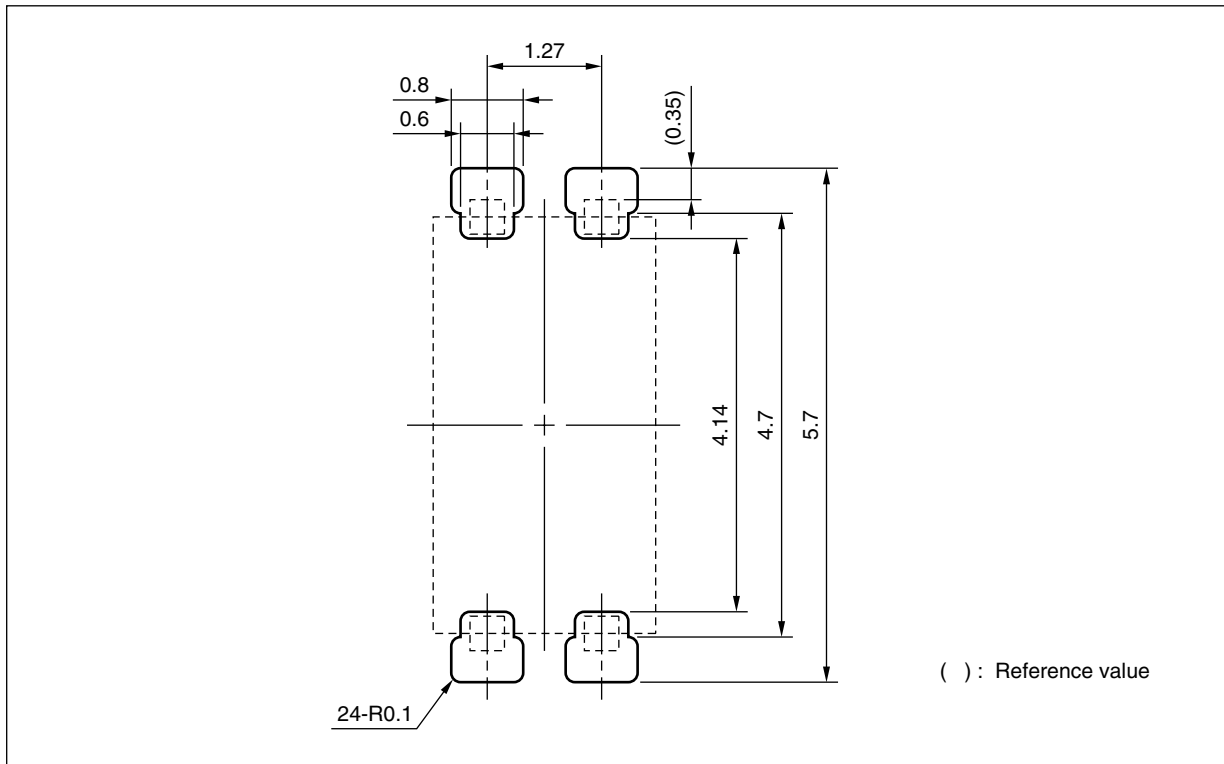
Tape Direction



Outline and Dimensions (Reel)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark This drawing is considered to meet air and outer creepage distance 4.0 mm minimum. All dimensions in this figure must be evaluated before use.

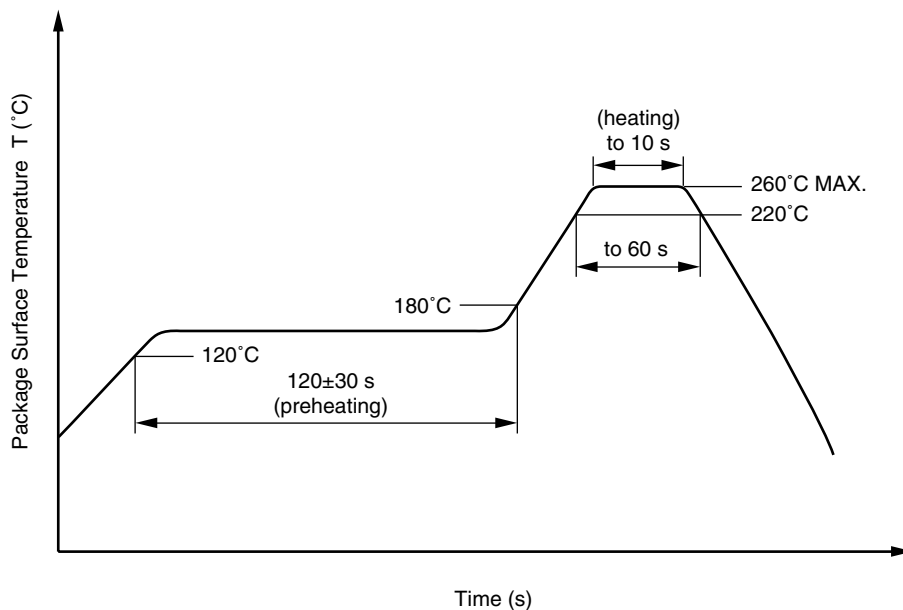
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

<R> **(3) Soldering by soldering iron**

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

<R> 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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| | | |
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|-----------------------|----------------------|---|

► For further information, please contact

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